

# Infonote

## AO-IN-2023-071-I

### New carrier technology at 100mm wafer processing

02.10.2023

Dear Customer,

please take note of this **Infonote**.

This customer notification is for information only and does not require customer approval.

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<b>Objective:</b>	New carrier technology at 100mm wafer processing
<b>Affected products:</b>	SPL DL85_3_900
<b>Reason for change:</b>	Change of carrier system and technology at carrier separation.
<b>Description of change:</b>	For details refer to file 2_cip_AO-IN-2023-071-I
<b>Time schedule:</b>	Intended Start of Introduction: January 2024
<b>Assessment:</b>	No changes in fit, form, function and reliability of the product.
<b>Documentation:</b>	Customer information package 2_cip_AO-IN-2023-071-I

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